

The Future of Analog IC Technology

# DESCRIPTION

The MP1924 is a high-frequency, 100V, halfbridge, N-channel, power MOSFET driver. Its low-side and high-side driver channels are independently controlled and matched with less than 5ns in time delay. Under-voltage lockout on both high-side and low-side supplies force their outputs low in case of insufficient supply. The integrated bootstrap diode reduces external component count.

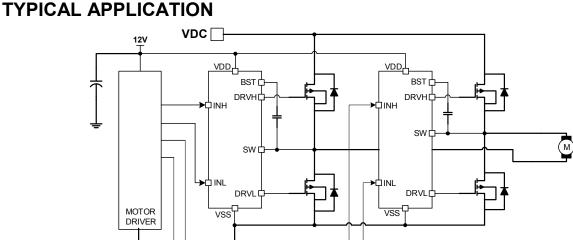
# FEATURES

- Drives an N-Channel MOSFET Half Bridge
- 118V V<sub>BST</sub> Voltage Range
- On-Chip Bootstrap Diode
- Typical Propagation Delay of 20ns
- Gate Drive Matching of Less than 5ns
- Drives a 2.2nF Load with 15ns Rise Time and 12ns Fall Time at 12V VDD
- TTL-Compatible Input
- Quiescent Current of Less than 150µA
- UVLO for Both High Side and Low Side
- QFN-10 (4mmx4mm) and SOIC-8 Packages

# **APPLICATIONS**

- Motor Drivers
- Telecom Half-Bridge Power Supplies
- Avionics DC-DC Converters
- Two-Switch Forward Converters
- Active-Clamp Forward Converters

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#### MP1924 Rev. 1.0 1/14/2015

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## **ORDERING INFORMATION**

Part Number	Package	Top Marking		
MP1924HR*	QFN-10 (4x4mm)	See Below		
MP1924HS**	SOIC-8	See Below		

\* For Tape & Reel, add suffix –Z (e.g. MP1924HR–Z) For RoHS compliant packaging, add suffix –LF (e.g. MP1924HR–LF–Z) \*\* For Tape & Reel, add suffix –Z (e.g. MP1924HS–Z) For RoHS compliant packaging, add suffix –LF (e.g. MP1924HS–LF–Z)

# **TOP MARKING (MP1924HR)**

MPSYWW

MP1924

LLLLLL

MPS: MPS prefix; Y: year code; WW: week code; MP1924: product code of MP1924HR; LLLLLLL: lot number;

# TOP MARKING (MP1924HS)

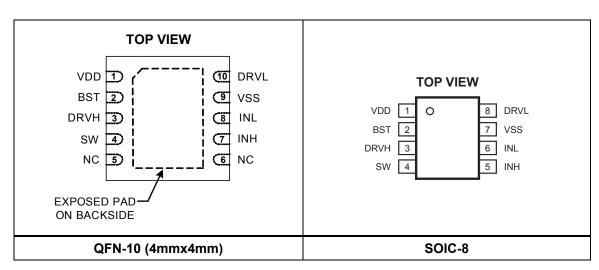
## MP1924

## LLLLLLL

## MPSYWW

MP1924: product code of MP1924HS; LLLLLLL: lot number; MPS: MPS prefix; Y: year code; WW: week code;





# PACKAGE REFERENCE

## ABSOLUTE MAXIMUM RATINGS (1)

Supply Voltage (V <sub>DD</sub> )0.3V to 18V SW Voltage (V <sub>SW</sub> )5.0V to 105V
BST Voltage (V <sub>BST</sub> )0.3V to 118V
BST to SW0.3V to 18V
DRVH to SW0.3V to (BST-SW) + 0.3V
DRVL to VSS0.3V to (VDD + 0.3V)
All Other Pins $0.3V$ to (V <sub>DD</sub> + $0.3V$ )
Continuous Power Dissipation $(T_A = 25^{\circ}C)^{(2)}$
QFN-10 (4mmx4mm)2.66W
SOIC-81.3W
Junction Temperature
Lead Temperature
Storage Temperature65°C to 150°C

# Recommended Operating Conditions <sup>(3)</sup>

Supply Voltage V <sub>DD</sub>	9.0V to 16.0V
SW Voltage (V <sub>SW</sub> )	1.0V to 100V
SW Slew Rate	<50V/ns
Operating Junction Temp. (T <sub>J</sub> ).	40°C to 125°C

# Thermal Resistance θJA θJC QFN-10 (4mmx4mm) 47 7 °C/W SOIC-8 96 45 °C/W

#### Notes:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature T<sub>J</sub>(MAX), the junction-to-ambient thermal resistance θ<sub>JA</sub>, and the ambient temperature T<sub>A</sub>. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P<sub>D</sub>(MAX)=(T<sub>J</sub>(MAX)-T<sub>A</sub>)/ θ<sub>JA</sub>. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- 3) The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.



# **ELECTRICAL CHARACTERISTICS**

# $V_{DD} = V_{BST}-V_{SW} = 12V$ , $V_{SS} = V_{SW} = 0V$ , No load at DRVH and DRVL, $T_A = +25^{\circ}C$ , unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Supply Currents						
VDD quiescent current	I <sub>DDQ</sub>	INL = INH = 0		100	150	μA
VDD operating current	I <sub>DDO</sub>	fsw = 500kHz		9		mA
Floating driver quiescent current	I <sub>BSTQ</sub>	INL = INH = 0		60	90	μA
Floating driver operating current	I <sub>BSTO</sub>	fsw = 500kHz		7.5		mA
Leakage current	I <sub>LK</sub>	BST = SW = 100V		0.05	1	μA
Inputs						
INL/INH High				2	2.4	V
INL/INH Low			1	1.4		V
INL/INH internal pull-down resistance	R <sub>IN</sub>			185		kΩ
Under Voltage Protection			·			
VDD rising threshold	V <sub>DDR</sub>		8.1	8.4	8.8	V
VDD hysteresis	V <sub>DDH</sub>			0.5		V
(BST-SW) rising threshold	V <sub>BSTR</sub>		6.9	7.3	7.7	V
(BST-SW) hysteresis	V <sub>BSTH</sub>			0.55		V
Bootstrap Diode			·			
Bootstrap diode VF @ 100µA	$V_{F1}$			0.5		V
Bootstrap diode VF @ 100mA	V <sub>F2</sub>			0.95		V
Bootstrap diode dynamic R	R <sub>D</sub>	@ 100mA		2		Ω
Low Side Gate Driver						
Low level output voltage	V <sub>OLL</sub>	I <sub>o</sub> = 100mA		0.08		V
High level output voltage to rail	V <sub>OHL</sub>	I <sub>o</sub> = -100mA		0.23		V
Source Current <sup>(5)</sup>	I <sub>OHL</sub>	$V_{DRVL} = 0V, V_{DD} = 12V$		3		А
Source Current		$V_{DRVL} = 0V, V_{DD} = 16V$		4.7		Α
Sink Current <sup>(5)</sup>	1	$V_{DRVL} = V_{DD} = 12V$		4.5		Α
	I <sub>OLL</sub>	$V_{DRVL} = V_{DD} = 16V$		6		А
Floating Gate Driver						
Low level output voltage Vol		I <sub>O</sub> = 100mA		0.08		V
High level output voltage to rail		I <sub>O</sub> = -100mA		0.23		V
Source Current <sup>(5)</sup>	I <sub>ОНН</sub>	$V_{DRVH}$ = 0V, $V_{DD}$ = 12V		2.6		А
		$V_{DRVH} = 0V, V_{DD} = 16V$		4		Α
Sink Current <sup>(5)</sup>	1	$V_{DRVH} = V_{DD} = 12V$		4.5		Α
	I <sub>OLH</sub>	$V_{DRVH} = V_{DD} = 16V$		5.9		Α



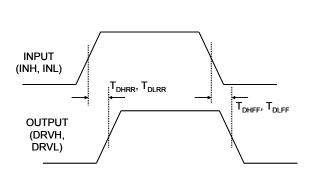
# ELECTRICAL CHARACTERISTICS (continued)

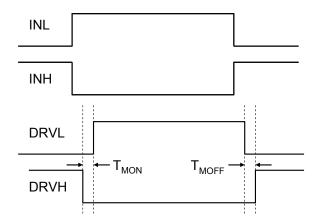
 $V_{DD} = V_{BST}-V_{SW} = 12V$ ,  $V_{SS} = V_{SW} = 0V$ , No load at DRVH and DRVL,  $T_A = +25^{\circ}C$ , unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Switching Spec Low Side Gate Driver						
Turn-off propagation delay INL falling to DRVL falling	$T_{DLFF}$			20		ns
Turn-on propagation delay INL rising to DRVL rising	T <sub>DLRR</sub>			20		
DRVL rise time		C <sub>L</sub> = 2.2nF		15		ns
DRVL fall time		C <sub>L</sub> = 2.2nF		9		ns
Switching Spec Floating Gate	e Driver					
Turn-off propagation delay INH falling to DRVH falling	$T_{DHFF}$			20		ns
Turn-on propagation delay INH rising to DRVH rising	T <sub>DHRR</sub>			20		ns
DRVH rise time		C <sub>L</sub> = 2.2nF		15		ns
DRVH fall time		C <sub>L</sub> = 2.2nF		12		ns
Switching Spec Matching					-	-
Floating driver turn-off to low side drive turn-on <sup>(5)</sup>	T <sub>MON</sub>			1	5	ns
Low side driver turn-off to floating driver turn-on <sup>(5)</sup>	$T_{MOFF}$			1	5	ns
Minimum input pulse width that changes the output <sup>(5)</sup>	$T_PW$				50	ns
Bootstrap diode turn-on or turn-off time $^{(5)}$	$T_{BS}$			10		ns
Thermal shutdown				150		°C
Thermal shutdown hysteresis				25		°C

Note:

5) Guaranteed by design.









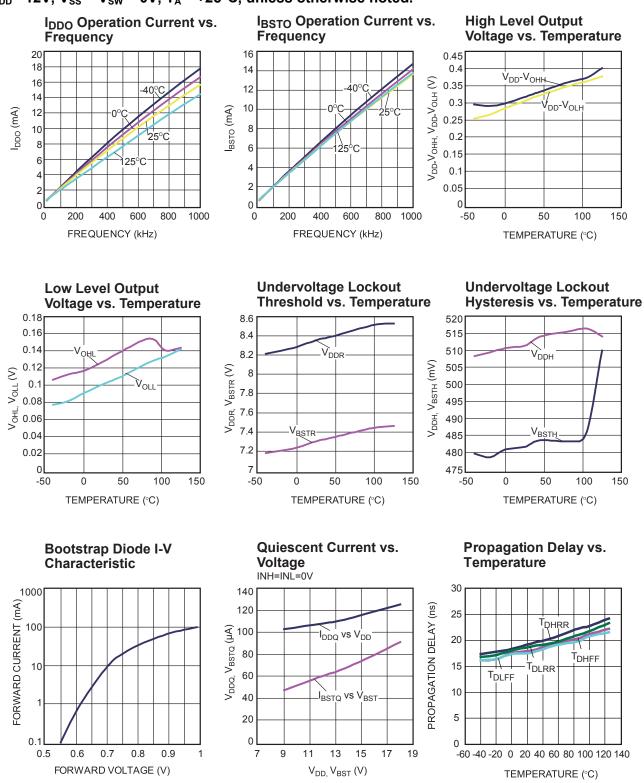
# **PIN FUNCTIONS**

QFN4x4-10 Pin #	SOIC-8 Pin #	Name	Description
1	1	VDD	Supply input. This pin supplies power to all the internal circuitry. Place a decoupling capacitor to ground close to this pin to ensure stable and clean supply.
2	2	BST	Bootstrap. This is the positive power supply for the internal floating high-side MOSFET driver. Connect a bypass capacitor between this pin and SW pin.
3	3	DRVH	Floating driver output.
4	4	SW	Switching node.
5, 6		NC	No connection.
7	5	INH	Control signal input for the floating driver.
8	6	INL	Control signal input for the low side driver.
9	7	VSS, exposed pad	Chip ground. Connect exposed pad to VSS for proper thermal operation.
10	8	DRVL	Low side driver output.



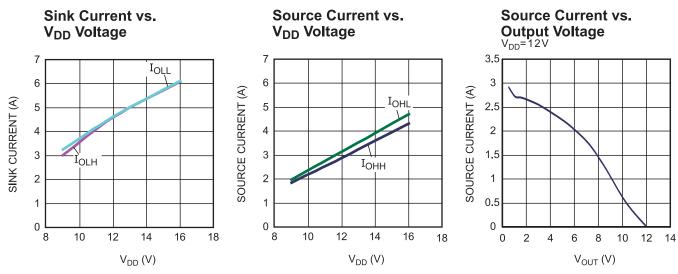
# **TYPICAL PERFORMANCE CHARACTERISTICS**

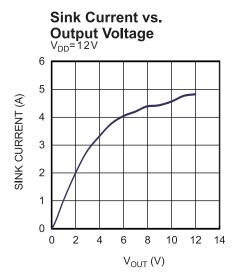
 $V_{DD}$  =12V,  $V_{SS}$  =  $V_{SW}$  = 0V,  $T_A$  = +25°C, unless otherwise noted.



# TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 $V_{DD}$  =12V,  $V_{SS}$  =  $V_{SW}$  = 0V,  $T_A$  = +25°C, unless otherwise noted.







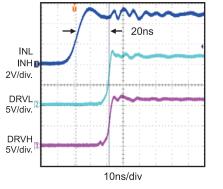
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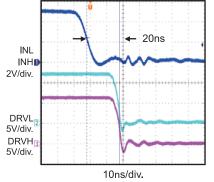
 $V_{\text{DD}}$  =12V,  $V_{\text{SS}}$  =  $V_{\text{SW}}$  = 0V,  $T_{\text{A}}$  = +25°C, unless otherwise noted.

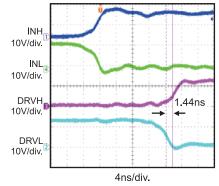
**Turn-on Propagation Delay** 

Turn-off Propagation Delay

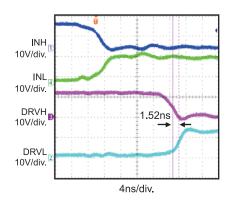
Gate Drive Matching T<sub>MOFF</sub>

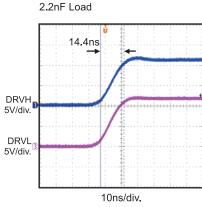




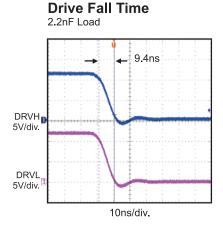


Gate Drive Matching T<sub>MON</sub>





**Drive Rise Time** 





# **BLOCK DIAGRAM**

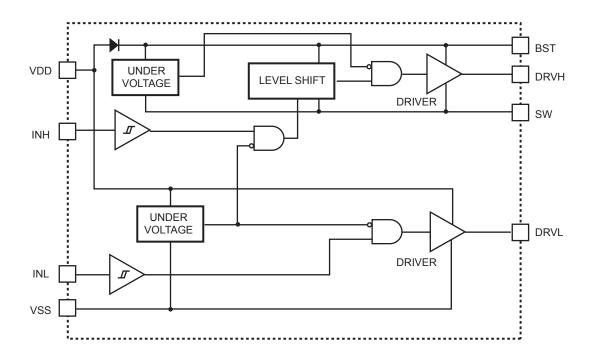


Figure 2: Function Block Diagram



# APPLICATION

The input signals of INH and INL can be controlled independently. If both INH and INL control the high-side MOSFET and low-side MOSFET of the same bridge, then users must avoid shoot through by setting sufficient dead time between INH and INL low, and vice versa. See Figure 3 below. Dead time is defined as the time interval between INH low and INL low.

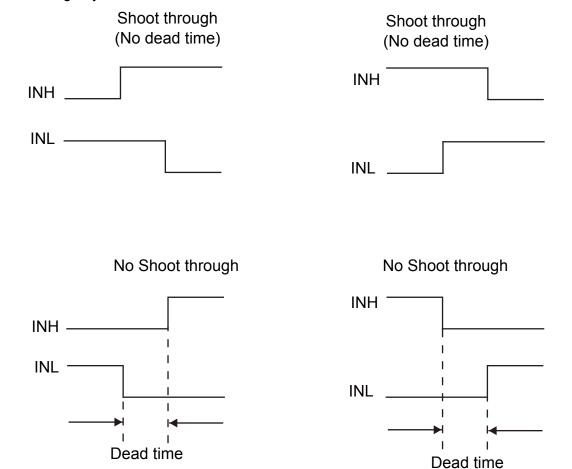


Figure 3: Shoot-Through Timing Diagram



## **REFERENCE DESIGN CIRCUITS**

## Half Bridge Converter

The MP1924 drives the MOSFETS with alternating signals (with dead time) in half-bridge converter topology. Therefore, from the PWM

controller drives INH and INL with alternating signals the input voltage can go up to 100V.

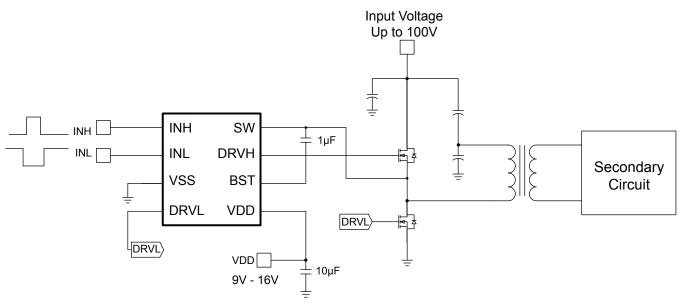


Figure 4: Half Bridge Converter

## **Two-Switch Forward Converter**

In two-switch forward converter topology, both MOSFETs are turned on and off simultaneously. The input signal (INH and INL) comes from a PWM controller that senses the output voltage (and output current during current-mode control).

The Schottky diodes clamp the reverse swing of the power transformer and must be rated for the input voltage. The input voltage can go up to 100V.

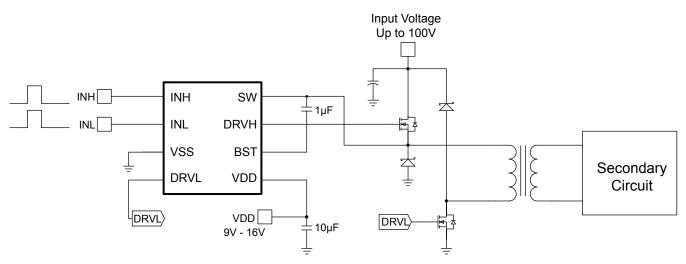


Figure 5: Two-Switch Forward Converter



## **Active-Clamp Forward Converter**

In active-clamp forward converter topology, the MP1924 drives the MOSFETs with alternating signals. The high-side MOSFET, in conjunction with  $C_{reset}$ , is used to reset the power transformer in a lossless manner.

This topology lends itself well to run at duty cycles exceeding 50%. The device may not be able to run at 100V under this topology.

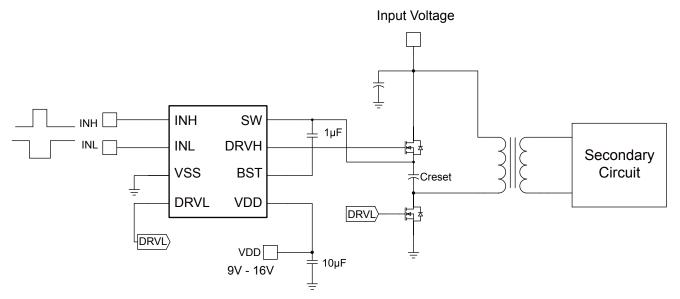
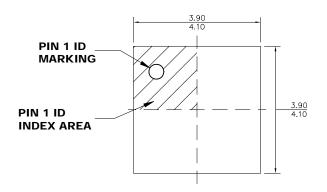


Figure 6 Active-Clamp Forward Converter

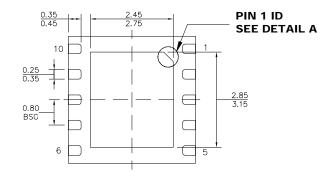


# **PACKAGE INFORMATION**

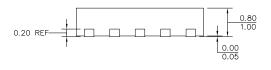
QFN-10 (4mm×4mm)



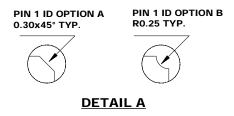
TOP VIEW

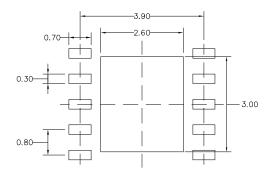


**BOTTOM VIEW** 



SIDE VIEW





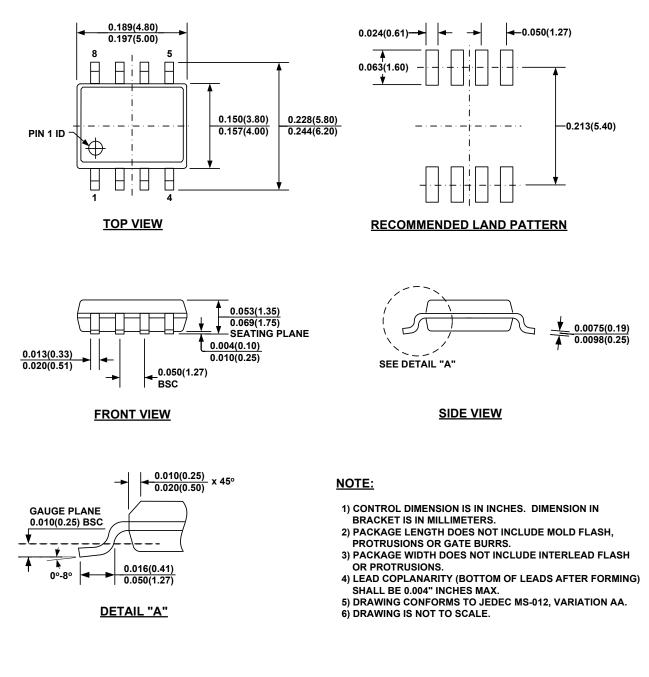
## RECOMMENDED LAND PATTERN

## NOTE:

 ALL DIMENSIONS ARE IN MILLIMETERS.
 EXPOSED PADDLE SIZE DOES NOT INCLUDE MOLD FLASH.
 LEAD COPLANARITY SHALL BE 0.10 MILLIMETERS MAX.
 JEDEC REFERENCE IS MO-220.
 DRAWING IS NOT TO SCALE.



SOIC-8



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